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[VS-ST380CH04C0](#)

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## VS-ST380CH Series

Vishay Semiconductors

### Phase Control Thyristors (Hockey PUK Version), 960 A



TO-200AB (E-PUK)

#### PRODUCT SUMMARY

Package	TO-200AB (E-PUK)
Diode variation	Single SCR
$I_{T(AV)}$	960 A
$V_{DRM}/V_{RRM}$	400 V, 600 V
$V_{TM}$	1.58 V
$I_{GT}$	100 mA
$T_J$	-40 °C to 150 °C

#### FEATURES

- Center amplifying gate
- Metal case with ceramic insulator
- International standard case TO-200AB (E-PUK)
- Extended temperature range
- Low profile hockey PUK to increase current-carrying capability
- Designed and qualified for industrial level
- Material categorization: For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT

#### TYPICAL APPLICATIONS

- DC motor controls
- Controlled DC power supplies
- AC controllers

#### MAJOR RATINGS AND CHARACTERISTICS

PARAMETER	TEST CONDITIONS	VALUES	UNITS
$I_{T(AV)}$		960	A
	$T_{hs}$	80	°C
$I_{T(RMS)}$		2220	A
	$T_{hs}$	25	°C
$I_{TSM}$	50 Hz	12 500	A
	60 Hz	13 000	
$I^2t$	50 Hz	782	kA <sup>2</sup> s
	60 Hz	713	
$V_{DRM}/V_{RRM}$		400 to 600	V
$t_q$	Typical	100	μs
$T_J$		-40 to 150	°C

#### ELECTRICAL SPECIFICATIONS

##### VOLTAGE RATINGS

TYPE NUMBER	VOLTAGE CODE	$V_{DRM}/V_{RRM}$ , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE V	$V_{RSM}$ , MAXIMUM NON-REPETITIVE PEAK VOLTAGE V	$I_{DRM}/I_{RRM}$ MAXIMUM AT $T_J = T_J$ MAXIMUM mA
VS-ST380CH..C	04	400	500	100
	06	600	700	



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ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES
Maximum average on-state current at heatsink temperature	$I_{T(AV)}$	180° conduction, half sine wave double side (single side) cooled		960 (440)
				80 (110)
Maximum RMS on-state current	$I_{T(RMS)}$	DC at 25 °C heatsink temperature double side cooled		2220
Maximum peak, one-cycle non-repetitive surge current	$I_{TSM}$	t = 10 ms	No voltage reapplied	12 500
		t = 8.3 ms	No voltage reapplied	13 000
		t = 10 ms	100 % $V_{RRM}$ reapplied	10 500
		t = 8.3 ms	100 % $V_{RRM}$ reapplied	11 000
Maximum $I^2t$ for fusing	$I^2t$	t = 10 ms	No voltage reapplied	782
		t = 8.3 ms	No voltage reapplied	713
		t = 10 ms	100 % $V_{RRM}$ reapplied	553
		t = 8.3 ms	100 % $V_{RRM}$ reapplied	505
Maximum $I^2\sqrt{t}$ for fusing	$I^2\sqrt{t}$	t = 0.1 to 10 ms, no voltage reapplied		7820
Low level value of threshold voltage	$V_{T(TO)1}$	$(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)})$ , $T_J = T_J$ maximum		0.85
High level value of threshold voltage	$V_{T(TO)2}$	$(I > \pi \times I_{T(AV)})$ , $T_J = T_J$ maximum		0.88
Low level value of on-state slope resistance	$r_{t1}$	$(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)})$ , $T_J = T_J$ maximum		0.25
High level value of on-state slope resistance	$r_{t2}$	$(I > \pi \times I_{T(AV)})$ , $T_J = T_J$ maximum		0.24
Maximum on-state voltage	$V_{TM}$	$I_{pk} = 2900$ A, $T_J = T_J$ maximum, $t_p = 10$ ms sine pulse		1.58
Maximum holding current	$I_H$	$T_J = 25$ °C, anode supply 12 V resistive load		600
Typical latching current	$I_L$			1000

SWITCHING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum non-repetitive rate of rise of turned-on current	$di/dt$	Gate drive 20 V, 20 $\Omega$ , $t_r \leq 1$ $\mu$ s $T_J = T_J$ maximum, anode voltage $\leq 80\%$ $V_{DRM}$	1000	A/ $\mu$ s
Typical delay time	$t_d$	Gate current 1 A, $di_g/dt = 1$ A/ $\mu$ s $V_d = 0.67\%$ $V_{DRM}$ , $T_J = 25$ °C	1.0	$\mu$ s
Typical turn-off time	$t_q$	$I_{TM} = 550$ A, $T_J = T_J$ maximum, $di/dt = 40$ A/ $\mu$ s, $V_R = 50$ V, $dV/dt = 20$ V/ $\mu$ s, gate 0 V 100 $\Omega$ , $t_p = 500$ $\mu$ s	100	

BLOCKING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum critical rate of rise of off-state voltage	$dV/dt$	$T_J = T_J$ maximum linear to 80 % rated $V_{DRM}$	500	V/ $\mu$ s
Maximum peak reverse and off-state leakage current	$I_{RRM}, I_{DRM}$	$T_J = T_J$ maximum, rated $V_{DRM}/V_{RRM}$ applied	100	mA



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TRIGGERING						
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES		UNITS
				TYP.	MAX.	
Maximum peak gate power	P <sub>GM</sub>	T <sub>J</sub> = T <sub>J</sub> maximum, t <sub>p</sub> ≤ 5 ms		10.0		W
Maximum average gate power	P <sub>G(AV)</sub>	T <sub>J</sub> = T <sub>J</sub> maximum, f = 50 Hz, d% = 50		2.0		
Maximum peak positive gate current	I <sub>GM</sub>	T <sub>J</sub> = T <sub>J</sub> maximum, t <sub>p</sub> ≤ 5 ms		3.0		A
Maximum peak positive gate voltage	+ V <sub>GM</sub>	T <sub>J</sub> = T <sub>J</sub> maximum, t <sub>p</sub> ≤ 5 ms		20		V
Maximum peak negative gate voltage	- V <sub>GM</sub>			5.0		
DC gate current required to trigger	I <sub>GT</sub>	T <sub>J</sub> = -40 °C	Maximum required gate trigger/ current/voltage are the lowest value which will trigger all units 12 V anode to cathode applied	200	-	mA
		T <sub>J</sub> = 25 °C		100	200	
		T <sub>J</sub> = 150 °C		40	-	
DC gate voltage required to trigger	V <sub>GT</sub>	T <sub>J</sub> = -40 °C		2.5	-	V
		T <sub>J</sub> = 25 °C		1.8	3.0	
		T <sub>J</sub> = 150 °C		1.0	-	
DC gate current not to trigger	I <sub>GD</sub>	T <sub>J</sub> = T <sub>J</sub> maximum	Maximum gate current/voltage not to trigger is the maximum value which will not trigger any unit with rated V <sub>DRM</sub> anode to cathode applied	10		mA
DC gate voltage not to trigger	V <sub>GD</sub>			0.25		V

THERMAL AND MECHANICAL SPECIFICATIONS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum operating junction temperature range	T <sub>J</sub>		-40 to 150	°C
Maximum storage temperature range	T <sub>Stg</sub>			
Maximum thermal resistance, junction to heatsink	R <sub>thJ-hs</sub>	DC operation single side cooled	0.09	K/W
		DC operation double side cooled	0.04	
Maximum thermal resistance, case to heatsink	R <sub>thC-hs</sub>	DC operation single side cooled	0.02	
		DC operation double side cooled	0.01	
Mounting force, ± 10 %			9800 (1000)	N (kg)
Approximate weight			83	g
Case style		See dimensions - link at the end of datasheet	TO-200AB (E-PUK)	

$\Delta R_{thJ-hs}$ CONDUCTION						
CONDUCTION ANGLE	SINUSOIDAL CONDUCTION		RECTANGULAR CONDUCTION		TEST CONDITIONS	UNITS
	SINGLE SIDE	DOUBLE SIDE	SINGLE SIDE	DOUBLE SIDE		
180°	0.010	0.011	0.007	0.007	T <sub>J</sub> = T <sub>J</sub> maximum	K/W
120°	0.012	0.012	0.012	0.013		
90°	0.015	0.015	0.016	0.017		
60°	0.022	0.022	0.023	0.023		
30°	0.036	0.036	0.036	0.037		

### Note

- The table above shows the increment of thermal resistance  $R_{thJ-hs}$  when devices operate at different conduction angles than DC



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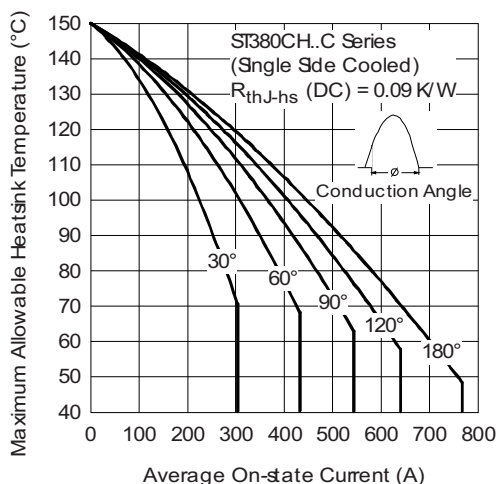


Fig. 1 - Current Ratings Characteristics

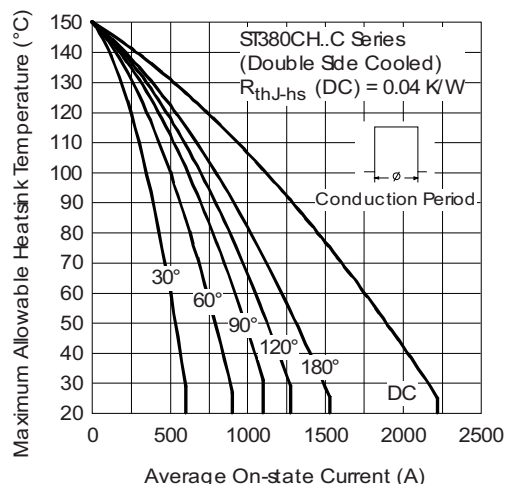


Fig. 4 - Current Ratings Characteristics

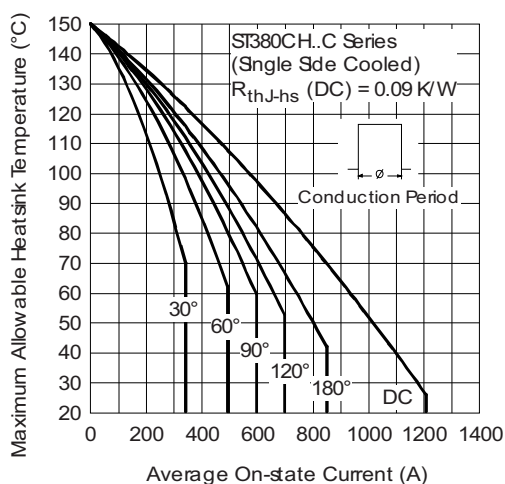


Fig. 2 - Current Ratings Characteristics

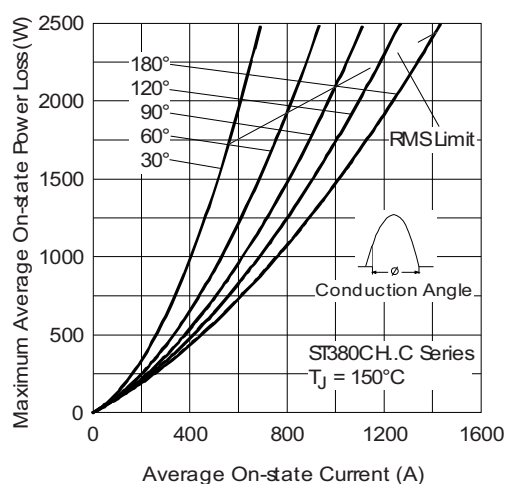


Fig. 5 - On-State Power Loss Characteristics

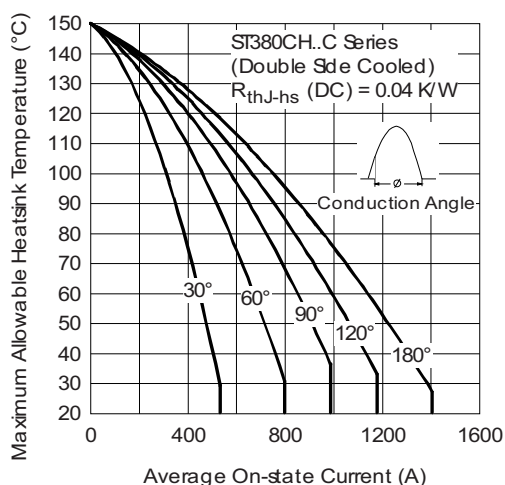


Fig. 3 - Current Ratings Characteristics

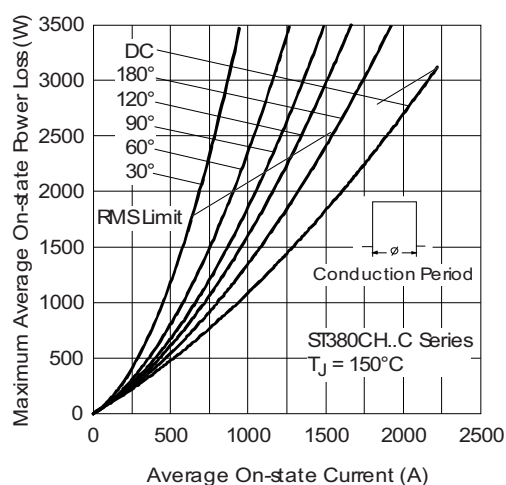


Fig. 6 - On-State Power Loss Characteristics



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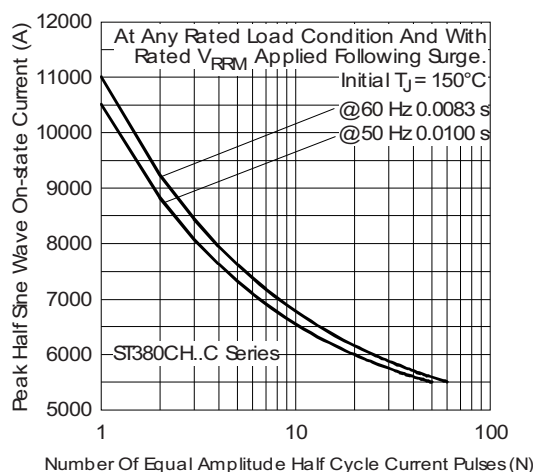


Fig. 7 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

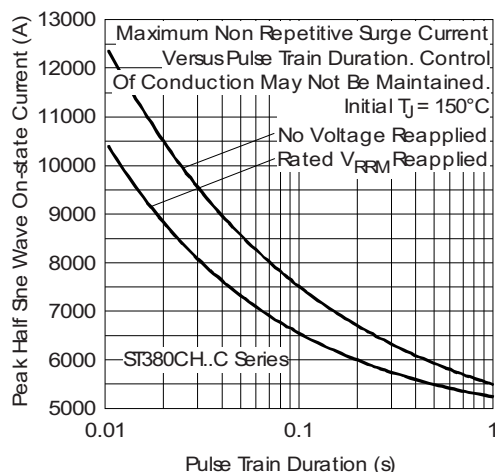


Fig. 8 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

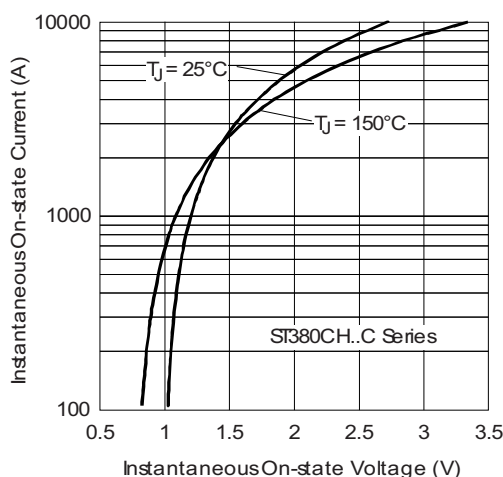


Fig. 9 - On-State Voltage Drop Characteristics

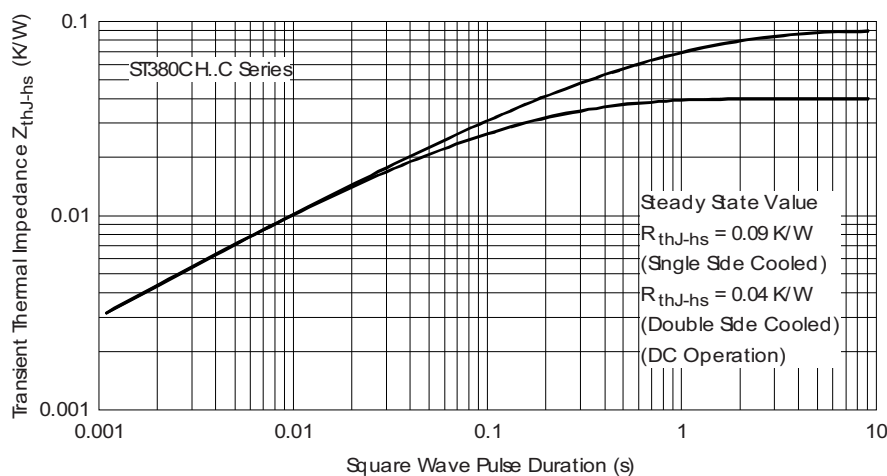


Fig. 10 - Thermal Impedance  $Z_{thJ-hs}$  Characteristics



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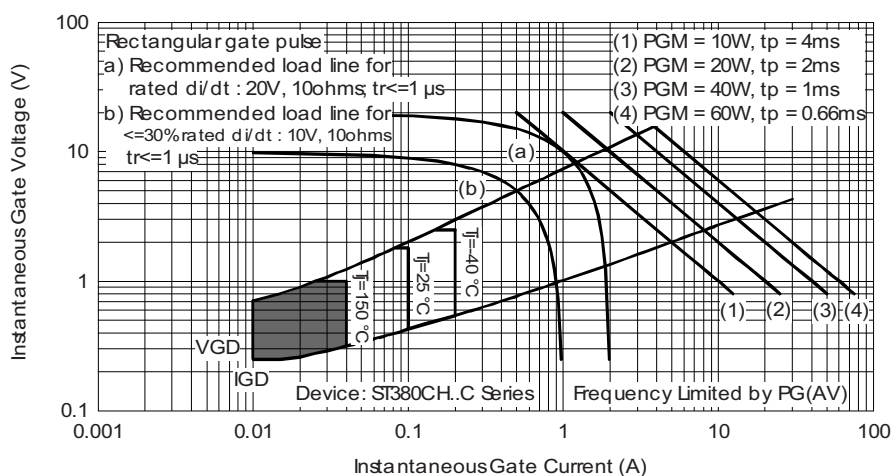


Fig. 11 - Gate Characteristics

### ORDERING INFORMATION TABLE

Device code	VS-	ST	38	0	CH	06	C	1	-
	①	②	③	④	⑤	⑥	⑦	⑧	⑨

①	-	Vishay Semiconductors product
②	-	Thyristor
③	-	Essential part number
④	-	0 = Converter grade
⑤	-	CH = Ceramic PUK, high temperature
⑥	-	Voltage code x 100 = $V_{RRM}$ (see Voltage Ratings table)
⑦	-	C = PUK case TO-200AB (E-PUK)
⑧	-	0 = Eyelet terminals (gate and auxiliary cathode unsoldered leads) 1 = Fast-on terminals (gate and auxiliary cathode unsoldered leads) 2 = Eyelet terminals (gate and auxiliary cathode soldered leads) 3 = Fast-on terminals (gate and auxiliary cathode soldered leads)
⑨	-	Critical $dV/dt$ : • None = 500 V/ $\mu\text{s}$ (standard selection) • L = 1000 V/ $\mu\text{s}$ (special selection)

#### LINKS TO RELATED DOCUMENTS

Dimensions

<http://www.vishay.com/doc?95075>



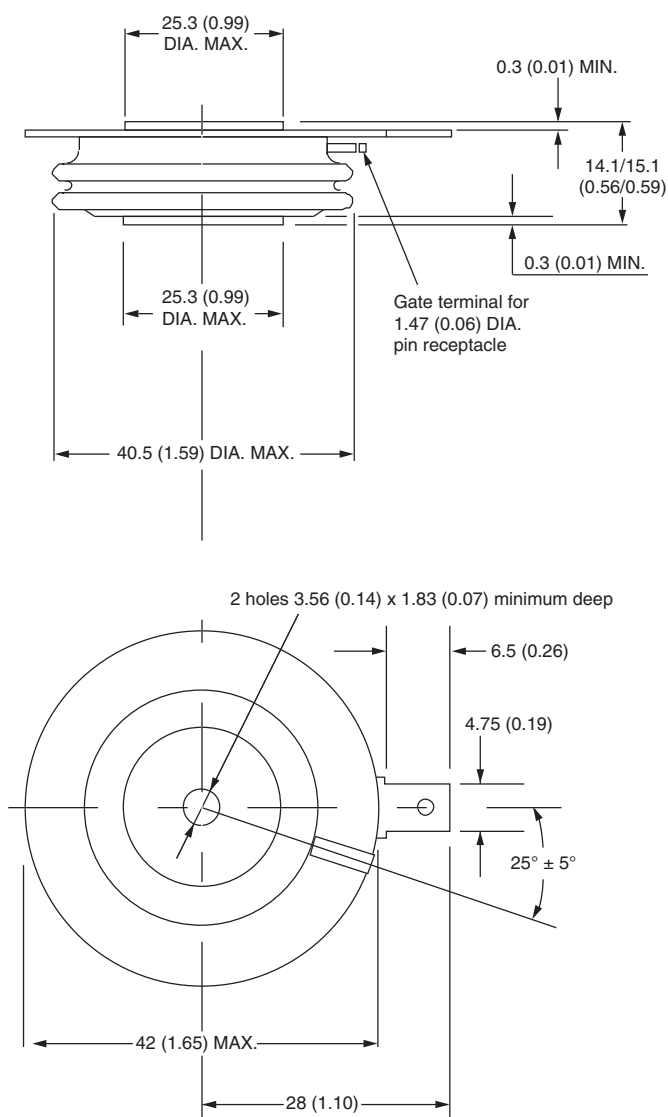
## Outline Dimensions

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### TO-200AB (E-PUK)

#### DIMENSIONS in millimeters (inches)

Anode to gate  
Creepage distance: 11.18 (0.44) minimum  
Strike distance: 7.62 (0.30) minimum



Quote between upper and lower pole pieces has to be considered after application of mounting force (see thermal and mechanical specification)





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